Preferred Devices

# **Dual Common Base-Collector Bias Resistor Transistors** NPN and PNP Silicon Surface Mount Transistors with Monolithic Bias Resistor Network

The BRT (Bias Resistor Transistor) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base–emitter resistor. These digital transistors are designed to replace a single device and its external resistor bias network. The BRT eliminates these individual components by integrating them into a single device. In the NSTB1002DXV5T1G series, two complementary devices are housed in the SOT–553 package which is ideal for low power surface mount applications where board space is at a premium.

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Available in 8 mm, 7 inch Tape and Reel
- These are Pb–Free Devices

**MAXIMUM RATINGS** ( $T_A = 25^{\circ}C$  unless otherwise noted, common for  $Q_1$  and  $Q_2$ , – minus sign for  $Q_1$  (PNP) omitted)

		Value		
Rating	Symbol	Q1	Q2	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-40	50	Vdc
Collector-Emitter Voltage	V <sub>CEO</sub>	-40	50	Vdc
Collector Current	Ι <sub>C</sub>	-200	100	mAdc

### THERMAL CHARACTERISTICS

Characteristic (One Junction Heated)	Symbol	Мах	Unit
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	P <sub>D</sub>	357 (Note 1) 2.9 (Note 1)	mW mW/°C
Thermal Resistance – Junction-to-Ambient	$R_{\thetaJA}$	350 (Note 1)	°C/W
Characteristic (Both Junctions Heated)	Symbol	Мах	Unit
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	P <sub>D</sub>	500 (Note 1) 4.0 (Note 1)	mW mW/°C
Thermal Resistance – Junction-to-Ambient	$R_{\thetaJA}$	250 (Note 1)	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stq</sub>	-55 to +150	°C

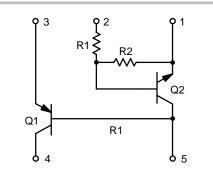
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR-4 @ Minimum Pad



# **ON Semiconductor®**

http://onsemi.com





CASE 463B

### MARKING DIAGRAM



U9 = Specific Device Code

- M = Date Code
- = Pb–Free Package
- (Note: Microdot may be in either location)

### **ORDERING INFORMATION**

Device	Package	Shipping
NSTB1002DXV5T1G		4 mm pitch 4000/Tape & Reel
NSTB1002DXV5T5G		2 mm pitch 8000/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit

Vdc

Vdc

Vdc

nAdc

nAdc

#### Q1 TRANSISTOR: PNP **OFF CHARACTERISTICS** Collector-Emitter Breakdown Voltage (Note 2) -40 V<sub>(BR)CEO</sub> \_ Collector-Base Breakdown Voltage -40 V<sub>(BR)CBO</sub> \_ Emitter-Base Breakdown Voltage -5.0 V<sub>(BR)EBO</sub> \_ Base Cutoff Current -50 $I_{BL}$ \_ Collector Cutoff Current -50 $I_{CEX}$ \_ **ON CHARACTERISTICS** (Note 2) DC Current Gain h<sub>FE</sub>

		60 80 100 60 30	_ 300 _ _	
Collector – Emitter Saturation Voltage ( $I_C = -10 \text{ mAdc}, I_B = -1.0 \text{ mAdc}$ ) ( $I_C = -50 \text{ mAdc}, I_B = -5.0 \text{ mAdc}$ )	V <sub>CE(sat)</sub>		-0.25 -0.4	Vdc
Base – Emitter Saturation Voltage $(I_{C} = -10 \text{ mAdc}, I_{B} = -1.0 \text{ mAdc})$ $(I_{C} = -50 \text{ mAdc}, I_{B} = -5.0 \text{ mAdc})$	V <sub>BE(sat)</sub>	-0.65 -	-0.85 -0.95	Vdc

#### SMALL-SIGNAL CHARACTERISTICS

Current-Gain – Bandwidth Product	f <sub>T</sub>	250	-	MHz
Output Capacitance	C <sub>obo</sub>	-	4.5	pF
Input Capacitance	C <sub>ibo</sub>	-	10.0	pF
Input Impedance ( $V_{CE} = -10 \text{ Vdc}, I_C = -1.0 \text{ mAdc}, f = 1.0 \text{ kHz}$ )	h <sub>ie</sub>	2.0	12	kΩ
Voltage Feedback Ratio $(V_{CE} = -10 \text{ Vdc}, I_C = -1.0 \text{ mAdc}, f = 1.0 \text{ kHz})$	h <sub>re</sub>	0.1	10	X 10 <sup>-4</sup>
Small – Signal Current Gain ( $V_{CE} = -10 \text{ Vdc}, I_C = -1.0 \text{ mAdc}, f = 1.0 \text{ kHz}$ )	h <sub>fe</sub>	100	400	-
Output Admittance ( $V_{CE} = -10$ Vdc, $I_C = -1.0$ mAdc, f = 1.0 kHz)	h <sub>oe</sub>	3.0	60	μmhos
Noise Figure (V <sub>CE</sub> = $-5.0$ Vdc, I <sub>C</sub> = $-100 \mu$ Adc, R <sub>S</sub> = $1.0 k\Omega$ , f = $1.0 kHz$ )	nF	-	4.0	dB

### SWITCHING CHARACTERISTICS

Delay Time	$(V_{CC} = -3.0 \text{ Vdc}, V_{BE} = 0.5 \text{ Vdc})$	t <sub>d</sub>	_	35	20
Rise Time	$(I_{C} = -10 \text{ mAdc}, I_{B1} = -1.0 \text{ mAdc})$	t <sub>r</sub>	-	35	ns
Storage Time	$(V_{CC} = -3.0 \text{ Vdc}, I_C = -10 \text{ mAdc})$	t <sub>s</sub>	-	225	20
Fall Time	(I <sub>B1</sub> = I <sub>B2</sub> = -1.0 mAdc)	t <sub>f</sub>	-	75	ns

### Q2 TRANSISTOR: NPN

#### **OFF CHARACTERISTICS**

Collector-Base Cutoff Current ( $V_{CB} = 50 \text{ V}, I_E = 0$ )	I <sub>CBO</sub>	-	-	100	nAdc
Collector-Emitter Cutoff Current $(V_{CB} = 50 \text{ V}, I_B = 0)$	I <sub>CEO</sub>	-	-	500	nAdc
Emitter-Base Cutoff Current ( $V_{EB} = 6.0, I_C = 5.0 \text{ mA}$ )	I <sub>EBO</sub>	-	-	0.1	mAdc

2. Pulse Test: Pulse Width  $\leq$  300  $\mu s;$  Duty Cycle  $\leq$  2.0%.

# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
ON CHARACTERISTICS					
Collector-Base Breakdown Voltage ( $I_C = 10 \ \mu A, I_E = 0$ )	V <sub>(BR)CBO</sub>	50	-	-	Vdc
Collector-Emitter Breakdown Voltage $(I_C = 2.0 \text{ mA}, I_B = 0)$	V <sub>(BR)CEO</sub>	50	-	-	Vdc
DC Current Gain $(V_{CE} = 10 \text{ V}, I_C = 5.0 \text{ mA})$	h <sub>FE</sub>	80	140	-	
Collector–Emitter Saturation Voltage $(I_C = 10 \text{ mA}, I_B = 0.3 \text{ mA})$	V <sub>CE(SAT)</sub>	-	-	0.25	Vdc
Output Voltage (on) $(V_{CC} = 5.0 \text{ V}, \text{ V}_{B} = 2.5 \text{ V}, \text{ R}_{L} = 1.0 \text{ k}\Omega)$	V <sub>OL</sub>	-	-	0.2	Vdc
Output Voltage (off) $(V_{CC} = 5.0 \text{ V}, \text{ V}_{B} = 0.5 \text{ V}, \text{ R}_{L} = 1.0 \text{ k}\Omega)$	V <sub>OH</sub>	4.9	-	-	Vdc
Input Resistor	R1	33	47	61	kΩ
Resistor Ratio	R1/R2	0.8	1.0	1.2	

2. Pulse Test: Pulse Width  $\leq$  300 µs; Duty Cycle  $\leq$  2.0%.

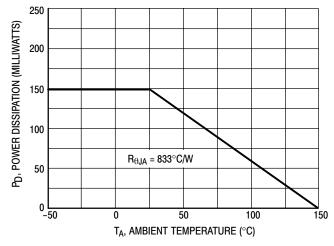
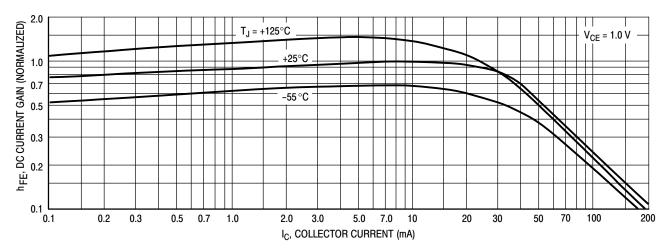


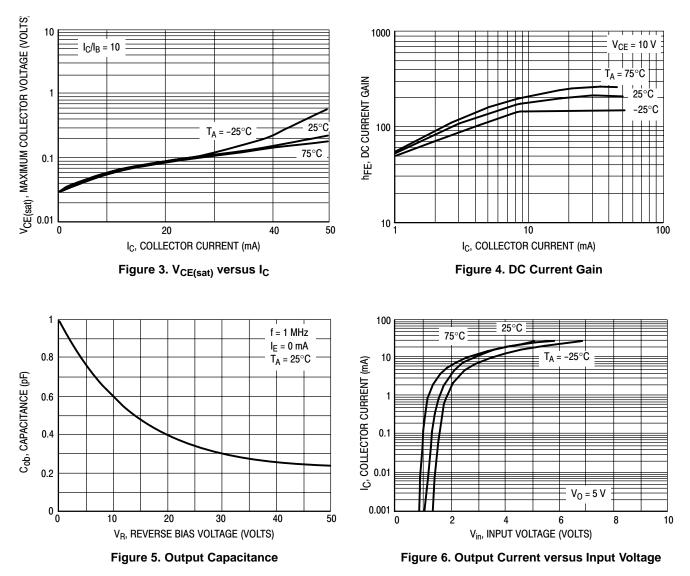
Figure 1. Derating Curve



### TYPICAL ELECTRICAL CHARACTERISTICS - PNP TRANSISTOR



### TYPICAL ELECTRICAL CHARACTERISTICS - NPN TRANSISTOR



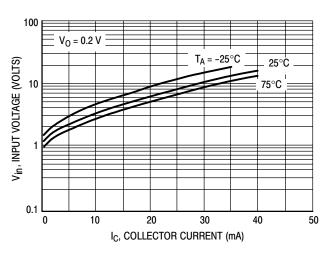
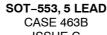


Figure 7. Input Voltage versus Output Current

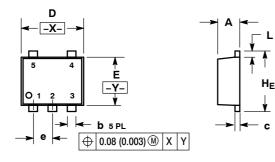




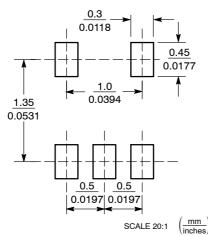
SCALE 4:1



ISSUE C



#### RECOMMENDED **SOLDERING FOOTPRINT\***



NOTES:

NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETERS 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MILLIMETERS			MILLIMETERS INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.50	0.55	0.60	0.020	0.022	0.024
b	0.17	0.22	0.27	0.007	0.009	0.011
С	0.08	0.13	0.18	0.003	0.005	0.007
D	1.55	1.60	1.65	0.061	0.063	0.065
E	1.15	1.20	1.25	0.045	0.047	0.049
е		0.50 BSC			0.020 BSC	)
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	1.55	1.60	1.65	0.061	0.063	0.065

# GENERIC **MARKING DIAGRAM\***

# XXM-

XX = Specific Device Code M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:
PIN 1. BASE	PIN 1. CATHODE	PIN 1. ANODE 1	PIN 1. SOURCE 1	PIN 1. ANODE
2. EMITTER	2. COMMON ANODE	2. N/C	2. DRAIN 1/2	2. EMITTER
3. BASE	3. CATHODE 2	3. ANODE 2	3. SOURCE 1	3. BASE
4. COLLECTOR	4. CATHODE 3	4. CATHODE 2	4. GATE 1	4. COLLECTOR
5. COLLECTOR	5. CATHODE 4	5. CATHODE 1	5. GATE 2	5. CATHODE
STYLE 6:	STYLE 7:	STYLE 8:	STYLE 9:	
PIN 1. EMITTER 2	PIN 1. BASE	PIN 1. CATHODE	PIN 1. ANODE	
2. BASE 2	2. EMITER	2. COLLECTOR	2. CATHODE	
3. EMITTER 1	3. BASE	3. N/C	3. ANODE	
4. COLLECTOR 1	4. COLLECTOR	4. BASE	4. ANODE	
5. COLLECTOR 2/BASE 1	5. COLLECTOR	5. EMITTER	5. ANODE	

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PAGE 2 OF 2

ISSUE	REVISION	DATE
Α	ADDED STYLES 3–9. REQ. BY D. BARLOW	11 NOV 2003
В	ADDED NOMINAL VALUES AND UPDATED GENERIC MARKING DIAGRAM. REQ. BY HONG XIAO	27 MAY 2005
С	UPDATED DIMENSIONS D, E, AND HE. REQ. BY J. LETTERMAN.	20 MAR 2013

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